

120 V, 1 A NPN/NPN low VCEsat transistor

24 October 2024

**Product data sheet** 

### 1. General description

NPN/NPN low  $V_{CEsat}$  transistor in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

NPN/PNP complement: PBSS4112PANP-Q

### 2. Features and benefits

- Very low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability  $I_C$  and  $I_{CM}$
- + High collector current gain  $h_{FE}$  at high  $I_C$
- Reduced Printed-Circuit Board (PCB) requirements
- High energy efficiency due to less heat generation
- Qualified according to AEC-Q101 and recommended for use in automotive applications

### 3. Applications

- Load switch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

### 4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor							
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-	120	V
I <sub>C</sub>	collector current			-	-	1	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-	1.5	А
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_C$ = 500 mA; $I_B$ = 50 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C		-	-	240	mΩ

# nexperia

# 5. Pinning information

Table 2	Table 2. Pinning information						
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	E1	emitter TR1					
2	B1	base TR1		C1 B2 E2			
3	C2	collector TR2					
4	E2	emitter TR2					
5	B2	base TR2					
6	C1	collector TR1	1 2 3	E1 B1 C2			
7	C1	collector TR1	Transparent top view	sym140			
8	C2	collector TR2	DFN2020-6 (SOT1118)				

# 6. Ordering information

Table 3. Ordering information   Type number Package				
	Name	Description	Version	
PBSS4112PAN-Q	DFN2020-6	plastic, leadless thermal enhanced ultra thin small outline package; no leads; 6 terminals; 0.65 mm pitch; 2 mm x 2 mm x 0.65 mm body	<u>SOT1118</u>	

# 7. Marking

Table 4.	Marking	codes
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Type number	Marking code
PBSS4112PAN-Q	2R

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transiste	or	1	I			
V <sub>CBO</sub>	collector-base voltage	open emitter		-	120	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	120	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	7	V
I <sub>C</sub>	collector current			-	1	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	1.5	А
I <sub>B</sub>	base current			-	0.3	А
I <sub>BM</sub>	peak base current	single pulse; t <sub>p</sub> ≤ 1 ms		-	1	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	370	mW
			[2]	-	570	mW
			[3]	-	530	mW
			[4]	-	700	mW
			[5]	-	450	mW
			[6]	-	760	mW
			[7]	-	700	mW
			[8]	-	1450	mW
Per device					-	_
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	510	mW
			[2]	-	780	mW
			[3]	-	730	mW
			[4]	-	960	mW
			[5]	-	620	mW
			[6]	-	1040	mW
			[7]	-	960	mW
			[8]	-	2000	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.

[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

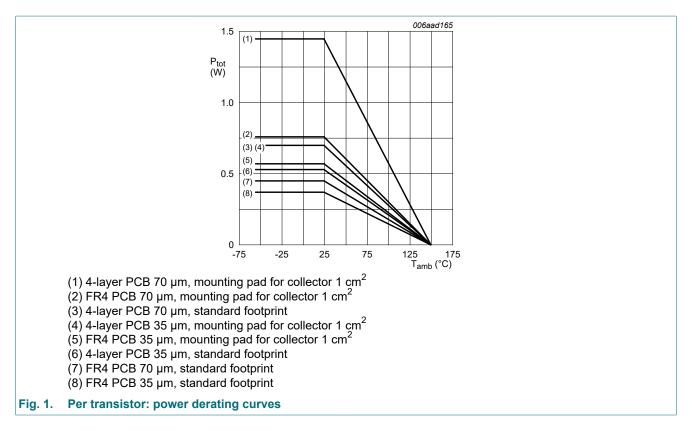
[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.

[6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

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### 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transist	tor						
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1]	-	-	338	K/W
junction to	junction to ambient		[2]	-	-	219	K/W
			[3]	-	-	236	K/W
			[4]	-	-	179	K/W
	[5]	[5]	-	-	278	K/W	
			[6]	-	-	164	K/W
	[7	[7]	-	-	179	K/W	
		[8]	-	-	86	K/W	
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	30	K/W
Per device							
R <sub>th(j-a)</sub> thermal resistance fr	thermal resistance from in free air	[1]	-	-	245	K/W	
	junction to ambient		[2]	-	-	160	K/W
			[3]	-	-	171	K/W
			[4]	-	-	130	K/W
			[5]	-	-	202	K/W
			[6]	-	-	120	K/W
			[7]	-	-	130	K/W
			[8]	-	-	63	K/W

[1] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.

[4] Device mounted on 4-layer PCB 35 μm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

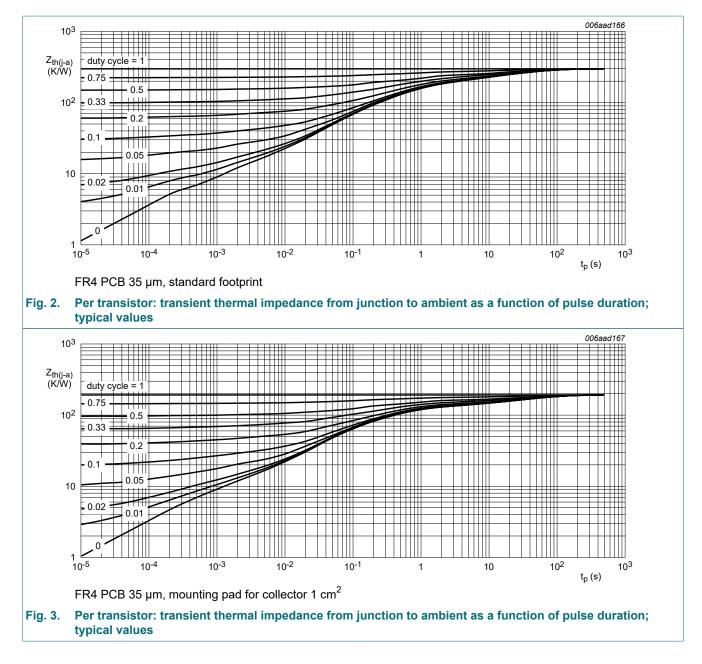
[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.

[6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

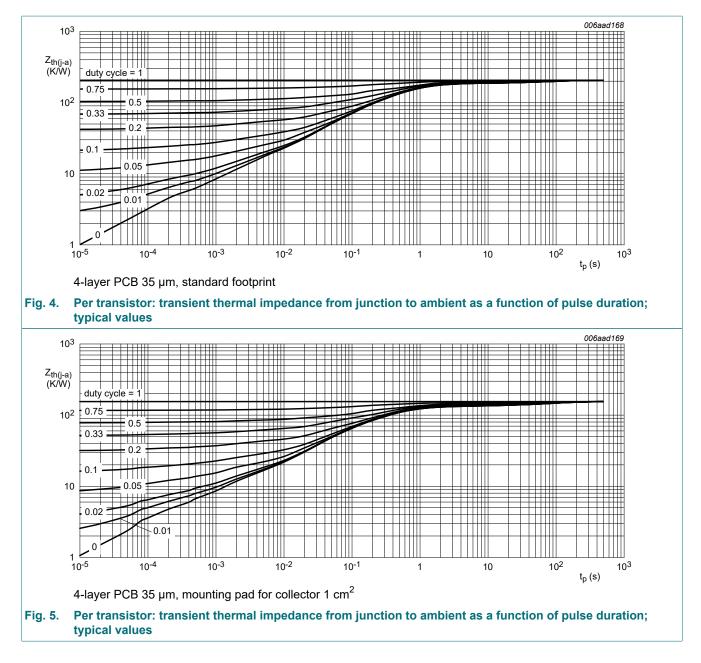
[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

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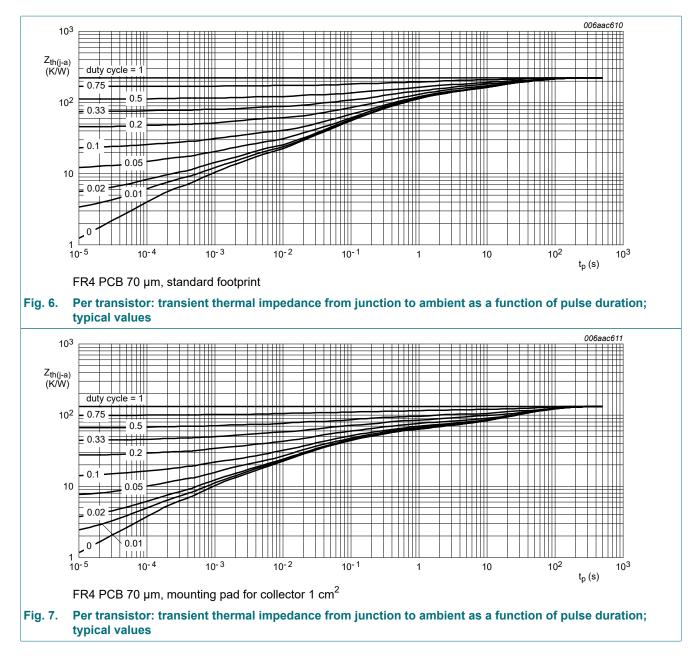


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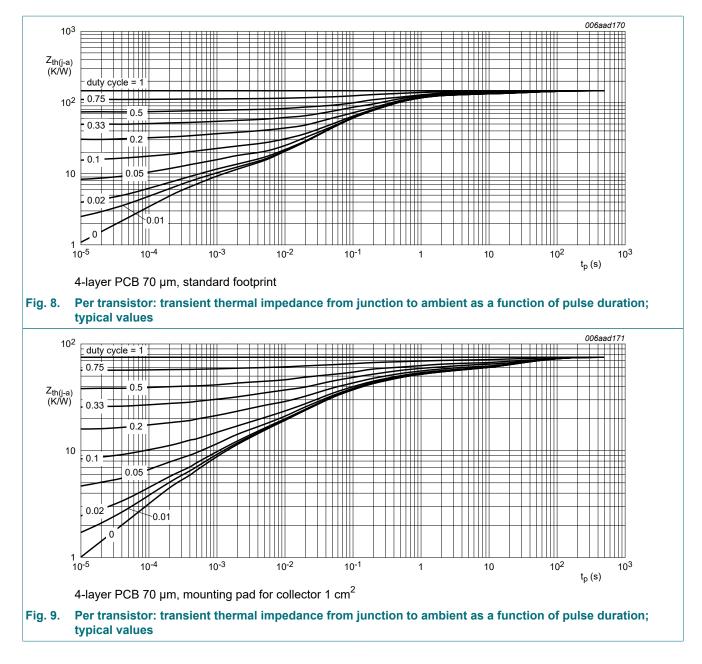


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**Product data sheet** 

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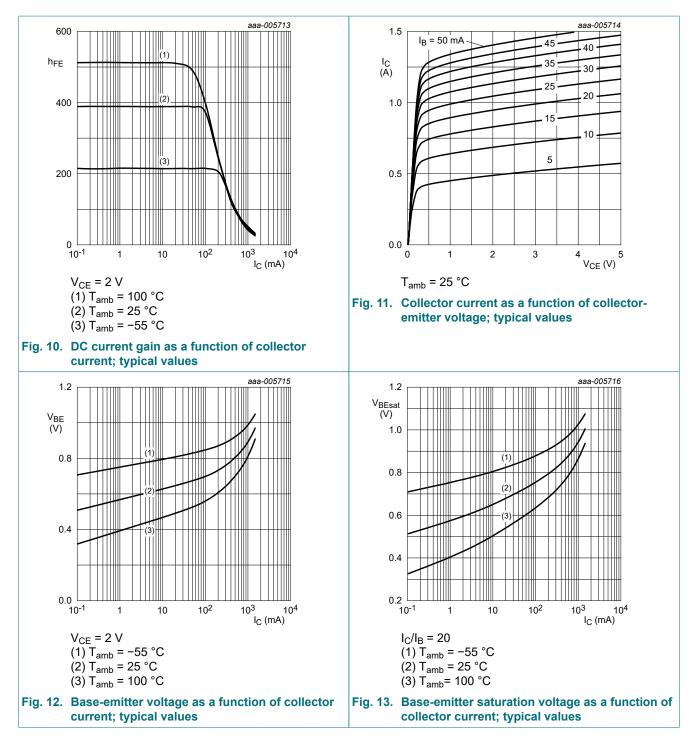


# **10. Characteristics**

Symbol	Parameter	Conditions	I	Min	Тур	Max	Unit
Per transist	or						
I <sub>CBO</sub>	collector-base cut-off	V <sub>CB</sub> = 96 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	-	100	nA
	current	V <sub>CB</sub> = 96 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C	-	-	-	50	μA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	•	-	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	2	240	375	-	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 500 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	(	60	100	-	
		$V_{CE}$ = 2 V; I <sub>C</sub> = 1 A; pulsed; t <sub>p</sub> ≤ 300 µs; $\delta$ ≤ 0.02; T <sub>amb</sub> = 25 °C	:	30	45	-	
V <sub>CEsat</sub>	collector-emitter	I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; T <sub>amb</sub> = 25 °C	-	-	90	120	mV
	saturation voltage	$I_C$ = 1 A; $I_B$ = 50 mA; pulsed; $t_p \le$ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	•	205	260	mV
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	-	170	220	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C}$ = 500 mA; $I_{B}$ = 50 mA; pulsed; $t_{p} \le$ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	•	-	240	mΩ
V <sub>BEsat</sub> base-em voltage	base-emitter saturation	I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; T <sub>amb</sub> = 25 °C	-	-	-	1	V
	voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	•	-	1.1	V
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	•	-	1.1	V
V <sub>BEon</sub>	base-emitter turn-on voltage	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 0.5 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	•	-	0.9	V
t <sub>d</sub>	delay time	V <sub>CC</sub> = 10 V; I <sub>C</sub> = 500 mA; I <sub>Bon</sub> = 25 mA;	-	-	20	-	ns
t <sub>r</sub>	rise time	I <sub>Boff</sub> = -25 mA; T <sub>amb</sub> = 25 °C	-	-	440	-	ns
t <sub>on</sub>	turn-on time		-	-	460	-	ns
t <sub>s</sub>	storage time		-	-	615	-	ns
t <sub>f</sub>	fall time		-	-	390	-	ns
t <sub>off</sub>	turn-off time		-	-	1005	-	ns
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 50 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C	(	60	120	-	MHz
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	-	4.5	7	pF

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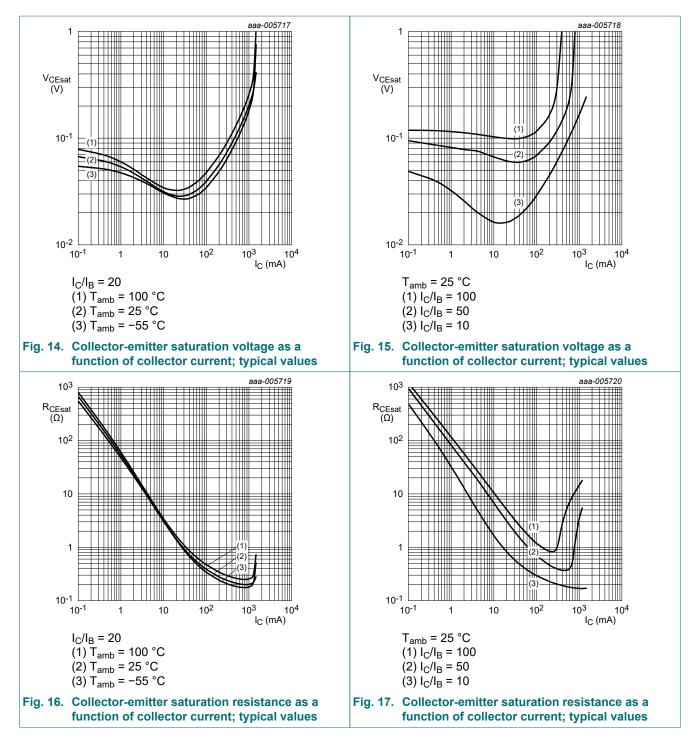
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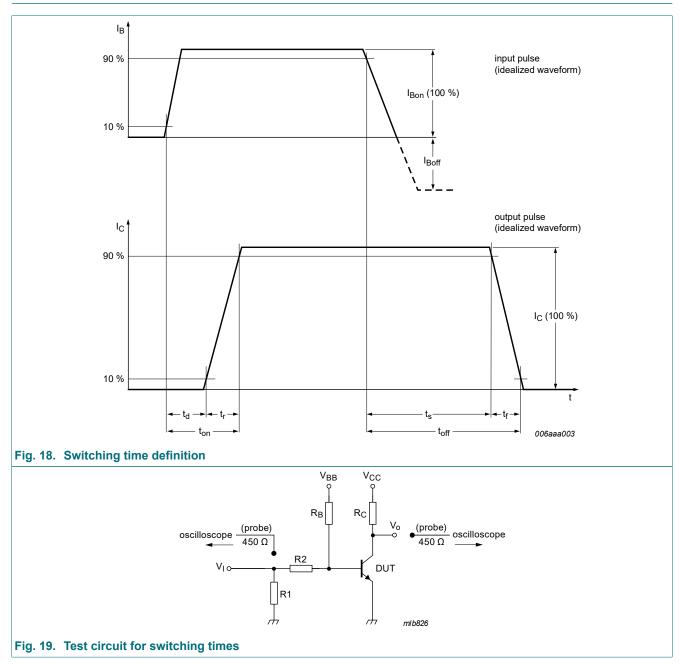
PBSS4112PAN-Q

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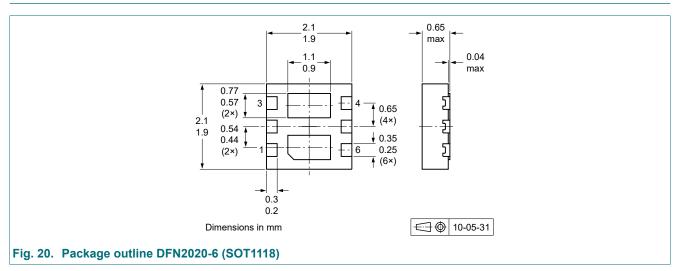
# **11. Test information**



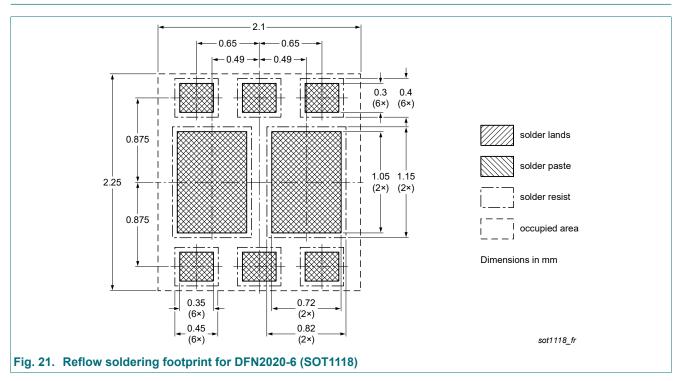
### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### 12. Package outline



### 13. Soldering



# 14. Revision history

Table 8. Revision history					
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes	
PBSS4112PAN-Q v.1	20241024	Product data sheet	-	-	

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

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